Lattice Semiconductor Corporation - LC51024VG-10F484C Datasheet

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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	32
Number of Macrocells	1024
Number of Gates	-
Number of I/O	304
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lc51024vg-10f484c

Enhanced Dual-OR Array

To facilitate logic functions requiring a very large number of product terms, the ispMACH 5000VG architecture has been enhanced with an innovative product term expander capability. This capability is embedded in the Dual-OR Array. The Dual-OR Array consists of 64 OR gates. There are two OR gates per macrocell in the GLB. These OR gates are referred to as the Expandable PTSA OR gate and the PTSA-Bypass OR gate.

The PTSA-Bypass OR gate receives its five inputs from the combination of product terms associated with the product term cluster. The PTSA-Bypass OR gate feeds the macrocell directly for fast narrow logic. The Expandable PTSA OR gate receives five inputs from the combination of product terms associated with the product term cluster. It also receives an additional input from the Expanded PTSA OR gate of the N-7 macrocell, where N is the number of the macrocell associated with the current OR gate. The Expandable PTSA OR gate feeds the PTSA for sharing with other product terms and the N+7 Expandable PTSA OR gate. This allows cascading of multiple OR gates for wide functions. There is a small timing adder for each level of expansion. Figure 5 is a graphical representation of the Enhanced Dual-OR Array.

Figure 5. Enhanced Dual-OR Array

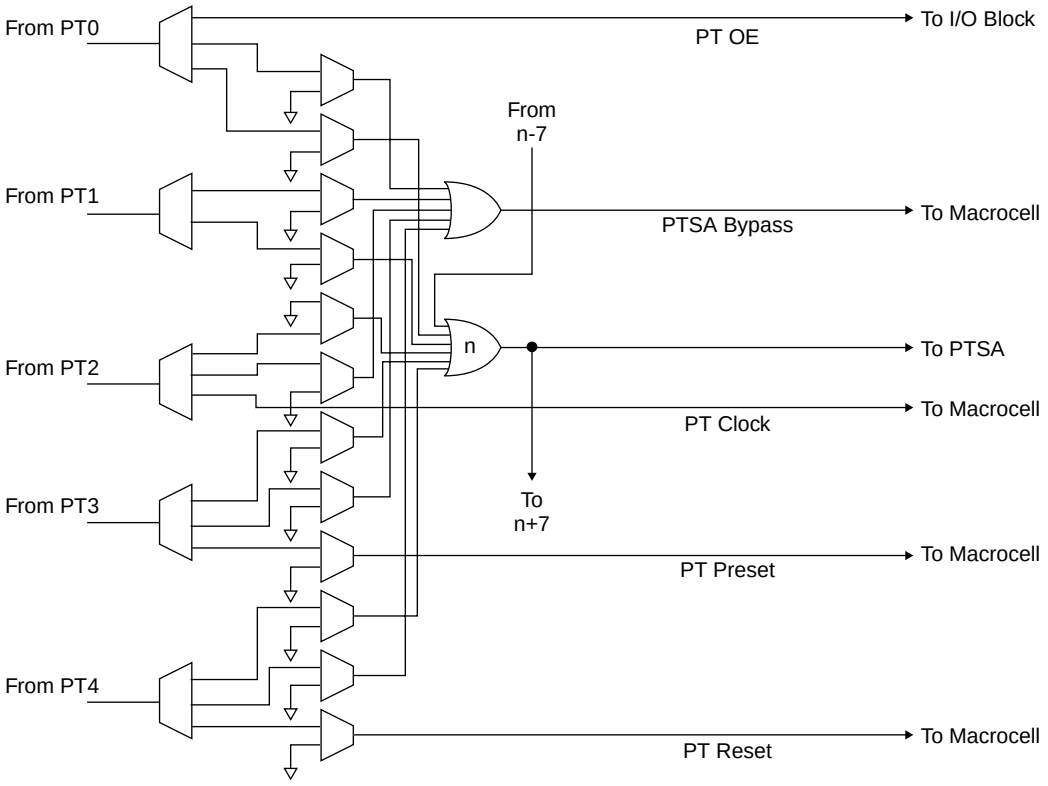
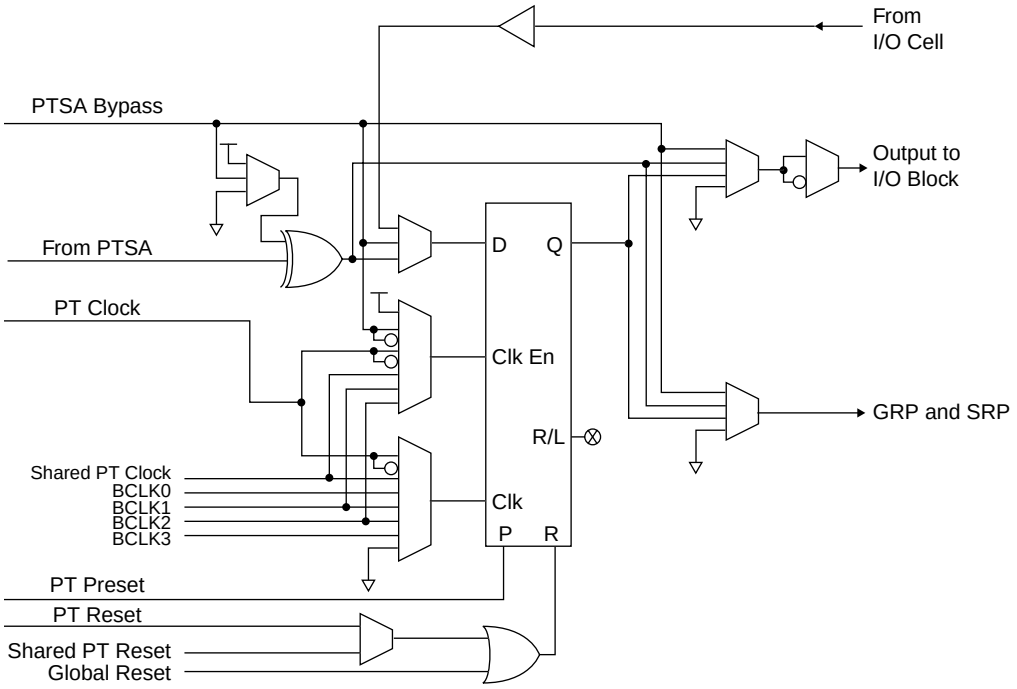


Figure 7. Macrocell



I/O Cell

The I/O cell of the ispMACH 5000VG device provides a high degree of flexibility. It includes the sysIO feature and an enhanced output enable MUX for optimal performance both on- and off-chip. The sysIO feature allows I/O cells to be configured to different I/O standards, drive strengths and slew rates. The enhanced output enable MUX provides up to 14 different output enable choices per I/O cell.

The I/O cell contains an output enable (OE) MUX, a programmable tri-state output buffer, a programmable input buffer, a programmable pull-up resistor, a programmable pull-down resistor and a programmable bus-keeper latch. The I/O cell receives its input from its associated macrocell. The I/O cell has a feedback line to its associated macrocell and a direct path to the GRP and SRP.

The output enable (OE) MUX selects the OE signal per I/O cell. The inputs to the OE MUX are the four Shared PTOE signals, PTOE and the two GOE signals. The OE MUX also has the ability to choose either the true or inverse of each of these signals. The output of the OE MUX goes through a logical AND with the TOE signal to allow easy tri-stating of the outputs for testing purposes.

The four shared PTOE signals are derived from PT163 of each GLB in the segment. The PTOE signal is derived from the first product term in each macrocell cluster, which is directly routed to the OE MUX. Therefore, every I/O cell can have a different OE signal. Figure 8 is a graphical representation of the I/O cell.

IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 5000VG devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic notes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port has its own supply voltage and can operate with LVCMOS3.3, 2.5 and 1.8V standards.

sysIO Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os' physical nature should be minimal so that board test time is minimized. The ispMACH 5000VG family of devices allows this by offering the user the ability to quickly configure the physical nature of the sysIO cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice's ispVM™ System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

IEEE 1532-Compliant In-System Programming

In-system programming of devices provides a number of significant benefits including rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispMACH 5000VG devices provide In-System Programming (ISP™) capability through their Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains compliant to the IEEE 1532 standard. By using IEEE 1532 as the communication interface through which ISP is achieved, customers get the benefit of a standard, well-defined interface.

The ispMACH 5000VG devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispMACH 5000VG devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 5000VG devices during the testing of a circuit board.

Security Bit

A programmable security bit is provided on the ispMACH 5000VG devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit prevents readback of the programmed pattern by a device programmer, securing proprietary design from competitors. The security bit also prevents programming and verification. The entire device must be erased in order to erase the security bit.

Hot Socketing

The ispMACH 5000VG devices are well suited for those applications that require hot socketing capability. Hot socketing a device requires that the device, when powered down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of the powered-down device be minimal on active signals.

Density Migration

The ispMACH 5000 family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

Absolute Maximum Ratings[1, 2, 3]

Supply Voltage (V_{CC}) . . . . . -0.5 to 5.4V

PLL Supply Voltage (V_{CCP}) . . . . . -0.5 to 5.4V

Output Supply Voltage (V_{CCO}) . . . . . -0.5 to 5.4V

Input Voltage Applied[4] . . . . . -0.5 to 5.6V

Tri-state Output Voltage Applied. . . . . -0.5 to 5.6V

Storage Temperature . . . . . -65 to 150°C

Junction Temperature (Tj) with Power Applied . . . . . -55 to 130°C

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with Lattice *Thermal Management* document is required.
3. All voltages referenced to GND.
4. Overshoot and Undershoot of -2V to (V_{IH} (MAX)+2) volts is permitted for a duration of < 20ns.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
V_{CC}	Supply Voltage	3.0	3.6	V
V_{CCP}	Supply Voltage for PLL block	3.0	3.6	V
V_{CCJ}	Supply Voltage for IEEE1149.1 Test Access Port	1.65	3.6	V
Tj (Commercial)	Junction Commercial Operation	0	90	C
Tj (Industrial)	Junction Industrial Operation	-40	105	C

Note: V_{CCJ} must be set in appropriate range to be compatible with desired LVCMOS standard.

Erase Reprogram Specifications

Parameter	Min	Max	Units
Erase/Reprogram Cycle	1000	—	Cycles

Hot Socketing Characteristics[1,2,3]

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{DK}	Input or I/O Leakage Current	$0 \le V_{IN} \le V_{IH}$ (MAX)	—	—	+/-100	µA
		V_{IH} (MAX) $\le V_{IN} \le$ 5.5V	—	—	+/-100	µA

1. Insensitive to sequence of V_{CC} and V_{CCO}. However, assumes monotonic rise / fall rates for V_{CC} and V_{CCO}.
2. LVTTL, LVCMOS only
3. $0 < V_{CC} \le V_{CC}$ (MAX), $0 < V_{CCO} \le V_{CCO}$ (MAX)

ispMACH 51024VG External Switching Characteristics

Over Recommended Operating Conditions

Parameter	Description[1,2,3]	-5		-75		-10		-12		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD}	Data propagation delay, 5-PT bypass	—	5.0	—	7.5	—	10.0	—	12.0	ns
t_{PD_PTSA}	Data propagation delay, intrasegment path	—	6.0	—	9.0	—	11.5	—	13.5	ns
t_{PD_GLOBAL}	Data propagation delay, intersegment path	—	6.5	—	9.75	—	13.0	—	16.0	ns
t_S	GLB register setup time before clock, 5-PT bypass	3.0	—	5.0	—	7.5	—	9.3	—	ns
t_{S_PTSA}	GLB register setup time before clock	3.0	—	6.0	—	8.5	—	10.0	—	ns
t_{SIR}	GLB register setup time before clock, input register path	2.8	—	3.0	—	4.0	—	5.0	—	ns
t_H	GLB register hold time before clock, 5-PT bypass	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{H_PTSA}	GLB register hold time before clock	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{HIR}	GLB register hold time before clock, input reg. path	0.0	—	0.0	—	0.0	—	0.0	—	ns
t_{CO}	GLB register clock-to-output delay	—	4.4	—	5.0	—	6.0	—	7.0	ns
t_R	External reset pin to output delay	—	6.5	—	9.0	—	10.0	—	10.9	ns
t_{RW}	External reset pulse duration	4.0	—	6.0	—	8.0	—	9.5	—	ns
$t_{LPTOE/DIS}$	Input to output local product term output enable/disable	—	7.0	—	9.75	—	11.5	—	13.4	ns
$t_{SPTOE/DIS}$	Input to output segment product term output enable/disable	—	8.0	—	11.25	—	17.5	—	20.4	ns
$t_{GOE/DIS}$	Global OE input to output enable/disable	—	6.2	—	7.5	—	8.85	—	10.0	ns
t_{CW}	Global clock width, high or low	1.6	—	2.75	—	3.6	—	4.3	—	ns
t_{GW}	Global gate width low (for low transparent) or high (for high transparent)	1.8	—	2.75	—	3.6	—	4.3	—	ns
t_{WIR}	Input register clock width, high or low	1.8	—	2.75	—	3.6	—	4.3	—	ns
t_{SKEW}	Clock-to-out skew, block level	—	0.25	—	0.35	—	0.45	—	0.55	ns
	Clock-to-out skew, segment level	—	0.4	—	0.5	—	0.6	—	0.7	ns
f_{MAX}[4]	Clock frequency with internal feedback	178.6	—	117.0	—	87.0	—	73.0	—	MHz
f_{MAX} (Ext.)	Clock frequency with external feedback, $1/ (t_{S\_PTSA} + t_{CO})$	135.1	—	90.9	—	69.0	—	58.8	—	MHz
f_{MAX} (Tog.)	Clock frequency max Toggle	312.5	—	181.0	—	138.0	—	116.0	—	MHz

Timing v.1.10

1. Timing numbers are based on default LVCMOS 3.3 I/O Buffers. Use timing adjusters provided to calculate timing for other standards.
2. Measured using standard switching circuit, assuming segment and global routing loading of 1, worst case PTSA loading and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using SRP feedback.

ispMACH 5768VG Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5		-75		-10		-12		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
In/Out Delays										
t_{IN}	Input Buffer Delay	—	0.65	—	0.95	—	1.25	—	1.40	ns
t_{GCLK_IN}	Global Clock Input Buffer Delay	—	0.65	—	0.95	—	1.25	—	1.40	ns
t_{GOE}	Global OE Pin Delay	—	4.05	—	5.00	—	6.00	—	7.00	ns
t_{BUF}	Delay through Output Buffer	—	1.15	—	1.50	—	1.75	—	1.90	ns
t_{EN}	Output Enable Time	—	2.15	—	2.50	—	2.85	—	3.00	ns
t_{DIS}	Output Disable Time	—	2.15	—	2.50	—	2.85	—	3.00	ns
t_{RSTb}	Global RESETbar Pin Delay	—	4.60	—	6.50	—	7.00	—	7.50	ns
Routing Delays										
t_{ROUTE}	Delay through SRP	—	2.80	—	4.20	—	5.65	—	6.90	ns
t_{PTSA}	Product Term Sharing Array Delay	—	0.40	—	1.85	—	2.35	—	2.50	ns
t_{PDB}	5-PT Bypass Propagation Delay	—	0.40	—	0.85	—	1.35	—	1.80	ns
t_{PDi}	Macrocell Propagation Delay	—	1.00	—	0.50	—	0.50	—	0.80	ns
t_{INREG}	Input Buffer to Macrocell Register Delay	—	3.00	—	3.05	—	3.50	—	4.40	ns
t_{FBK}	Internal Feedback Delay	—	0.00	—	0.00	—	0.00	—	0.00	ns
t_{GCLK}	Global Clock Tree Delay	—	0.85	—	0.70	—	0.55	—	0.65	ns
t_{PLL_DELAY}	Programmable PLL Delay Increment	—	0.50	—	0.50	—	0.50	—	0.50	ns
$t_{PLL\_SEC\_DELAY}$	Additional Delay When Using Secondary PLL Output	—	0.60	—	0.60	—	0.60	—	0.60	ns
t_{GRP}	Global Routing Pool Delay	—	1.50	—	2.25	—	3.00	—	4.00	ns
Register/Latch Delays										
t_{S}	D-Register Setup Time	0.65	—	0.65	—	1.05	—	1.25	—	ns
t_{S_PT}	D-Register Setup Time with PT Clock	0.65	—	0.65	—	1.05	—	1.25	—	ns
t_{H}	D-Register Hold Time	0.00	—	0.00	—	0.00	—	0.00	—	ns
t_{ST}	T-Register Setup Time	1.15	—	1.15	—	1.55	—	1.75	—	ns
t_{ST_PT}	T-Register Setup Time with PT Clock	1.15	—	1.15	—	1.55	—	1.75	—	ns
t_{HT}	T-Register Hold Time	0.00	—	0.00	—	0.00	—	0.00	—	ns
t_{COi}	Register Clock to Output/Feedback MUX Time	—	1.75	—	1.85	—	2.45	—	3.05	ns
t_{CES}	Clock Enable Setup Time	2.60	—	3.90	—	5.05	—	5.95	—	ns
t_{CEH}	Clock Enable Hold Time	0.60	—	0.90	—	1.20	—	1.45	—	ns
t_{SL}	Latch Setup Time	2.80	—	4.20	—	5.50	—	6.60	—	ns
t_{SL_PT}	Latch Setup Time with PT Clock	2.80	—	4.20	—	5.50	—	6.60	—	ns
t_{HL}	Latch Hold Time	0.00	—	0.00	—	0.00	—	0.00	—	ns
t_{GOi}	Latch Gate to Output/Feedback MUX Time	—	1.75	—	2.50	—	3.50	—	4.50	ns
t_{PDLi}	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	2.40	—	3.50	—	4.00	—	4.50	ns
t_{SRi}	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.75	—	1.00	—	1.25	—	1.50	ns
t_{SRR}	Asynchronous Reset or Set Recovery Delay	—	1.00	—	1.50	—	2.00	—	2.50	ns
Control Delays										
t_{BCLK}	GLB PT Clock Delay	—	3.10	—	4.65	—	6.00	—	7.00	ns
t_{PTCLK}	Macrocell PT Clock Delay	—	3.00	—	4.50	—	6.00	—	7.00	ns

ispMACH 5768VG Timing Adders

Adder Type	Base Parameter	Description	-5		-75		-10		-12		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{BLA}	t_{ROUTE}	GLB Loading Adder	—	0.0	—	0.0	—	0.0	—	0.0	ns
t_{EXP}	t_{PTSA}	PT Expander Adder	—	1.5	—	2.0	—	2.5	—	2.5	ns
t_{LP}	t_{ROUTE}	Low Power Adder	—	1.5	—	1.5	—	1.5	—	1.5	ns
t_{IOI} Input Adders											
LVCMOS18_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS1.8 standard	—	0.90	—	0.90	—	0.90	—	0.90	ns
LVCMOS25_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS2.5 standard	—	0.15	—	0.15	—	0.15	—	0.15	ns
LVCMOS33_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVCMOS3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVTTL	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using LVTTL standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using PCI standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_X_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using PCI_X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using AGP-1X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL3_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL3_I standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL3_II_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL3_II standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL2_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL2_I standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
SSTL2_II_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using SSTL2_II standard	—	1.00	—	1.00	—	1.00	—	1.00	ns
CTT33_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using CTT3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
CTT25_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using CTT2.5 standard	—	0.15	—	0.15	—	0.15	—	0.15	ns
HSTL_I_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using HSTL_I standard	—	1.25	—	1.25	—	1.25	—	1.25	ns
HSTL_III_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using HSTL_III standard	—	1.25	—	1.25	—	1.25	—	1.25	ns
GTL+_in	t_{IN}, t_{GCLK_IN}, t_{RSTb}, t_{GOE}	Using GTL+ standard	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVDS_in	t_{GCLK_IN}	Using LVDS standard	—	1.70	—	1.70	—	1.70	—	1.70	ns
LVPECL_in	t_{GCLK_IN}	Using LVPECL standard	—	2.10	—	2.10	—	2.10	—	2.10	ns
t_{IOO} Output Adders											
LVCMOS18_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 4mA Buffer	—	3.00	—	3.00	—	3.00	—	3.00	ns
LVCMOS18_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 5.33mA Buffer	—	2.50	—	2.50	—	2.50	—	2.50	ns
LVCMOS18_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 8mA Buffer	—	1.85	—	1.85	—	1.85	—	1.85	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.1.20

ispMACH 5768VG Timing Adders (Continued)

Adder Type	Base Parameter	Description	-5		-75		-10		-12		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
LVCMOS18_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 1.8V & 12mA Buffer	—	1.35	—	1.35	—	1.35	—	1.35	ns
LVCMOS25_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 4mA Buffer	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVCMOS25_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 5.33mA Buffer	—	1.25	—	1.25	—	1.25	—	1.25	ns
LVCMOS25_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 8mA Buffer	—	0.70	—	0.70	—	0.70	—	0.70	ns
LVCMOS25_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 12mA Buffer	—	0.50	—	0.50	—	0.50	—	0.50	ns
LVCMOS25_16mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 2.5V & 16mA Buffer	—	0.25	—	0.25	—	0.25	—	0.25	ns
LVCMOS33_4mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 4mA Buffer	—	1.50	—	1.50	—	1.50	—	1.50	ns
LVCMOS33_5mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 5.33mA Buffer	—	1.25	—	1.25	—	1.25	—	1.25	ns
LVCMOS33_8mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 8mA Buffer	—	0.40	—	0.40	—	0.40	—	0.40	ns
LVCMOS33_12mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 12mA Buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVCMOS33_16mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 16mA Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS33_20mA_out	t_{BUF}, t_{EN}, t_{DIS}	Output configured as 3.3V & 20mA Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVTTL	t_{BUF}, t_{EN}, t_{DIS}	Output configured as LVTTL Buffer	—	0.0	—	0.0	—	0.0	—	0.0	ns
Slow Slew	t_{BUF}, t_{EN}	Output configured for slow slew rate	—	1.50	—	1.50	—	1.50	—	1.50	ns
PCI_out	t_{BUF}, t_{EN}, t_{DIS}	Using PCI standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
PCI_X_out	t_{BUF}, t_{EN}, t_{DIS}	Using PCI-X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
AGP_1X_out	t_{BUF}, t_{EN}, t_{DIS}	Using AGP-1X standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL3_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL3_I standard	—	-0.25	—	-0.25	—	-0.25	—	-0.25	ns
SSTL3_II_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL3_II standard	—	-0.35	—	-0.35	—	-0.35	—	-0.35	ns
SSTL2_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_I standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL2_II_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_II standard	—	-0.25	—	-0.25	—	-0.25	—	-0.25	ns
CTT33_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
CTT25_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT2.5 standard	—	0.25	—	0.25	—	0.25	—	0.25	ns
HSTL_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using HSTL_I standard	—	-0.30	—	-0.30	—	-0.30	—	-0.30	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.1.20

ispMACH 51024VG Timing Adders (Continued)

Adder Type	Base Parameter	Description	-5		-75		-10		-12		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
SSTL2_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_I standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
SSTL2_II_out	t_{BUF}, t_{EN}, t_{DIS}	Using SSTL2_II standard	—	-0.25	—	-0.25	—	-0.25	—	-0.25	ns
CTT33_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT3.3 standard	—	0.0	—	0.0	—	0.0	—	0.0	ns
CTT25_out	t_{BUF}, t_{EN}, t_{DIS}	Using CCT2.5 standard	—	0.25	—	0.25	—	0.25	—	0.25	ns
HSTL_I_out	t_{BUF}, t_{EN}, t_{DIS}	Using HSTL_I standard	—	-0.30	—	-0.30	—	-0.30	—	-0.30	ns
HSTL_III_out	t_{BUF}, t_{EN}, t_{DIS}	Using HSTL_III standard	—	0.00	—	0.00	—	0.00	—	0.00	ns
GTL+_out	t_{BUF}, t_{EN}, t_{DIS}	Using GTL+ standard	—	0.30	—	0.30	—	0.30	—	0.30	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.1.10

ispMACH 51024 Power Supply and NC Connections[1]

Signal	484-Ball fpBGA[2]	676-Ball fpBGA[2]
V_{CC}	B17, B2, B21, B6, C14, C9, E18, E5, F2, F21, J20, J3, P20, P3, U2, U21, Y14, Y9, AA17, AA2, AA21, AA6	B29, D6, D10, D12, D19, D21, D25, F4, F27, K4, K27, M4, M27, W4, W27, AA4, AA27, AE4, AE27, AG6, AG10, AG12, AG19, AG21,AG25, AJ2
V_{CCO0}	B5, D7, E2, E6, E9, F5, G4, J5	E5, E7, E9, E11, F10, G5, J5, K6, L5
V_{CCO1}	P5, U5, V6, V9, Y3	Y5, AA6, AB5, AD5, AE10, AF5, AF7, AF9, AF11
V_{CCO2}	P18, U18, V14, V17, Y20	Y26, AA25, AB26, AD26, AE21, AF20, AF22, AF24, AF26
V_{CCO3}	B18, D16, E14, E17, E21, F18, G19, J18	E20, E22, E24, E26, F21, G26, J26, K25, L26
V_{CCP0}	L7	P5
V_{CCP1}	N18	N26
V_{CCJ}	P4	U6
V_{REF0}	A9	C11
V_{REF1}	AA10	AK10
V_{REF2}	AA13	AJ21
V_{REF3}	A15	E19
GND PLL 0	L6	R6
GND PLL 1	L16	P25
GND	A1, A22, C3, C20, D4, D19, E7, E16, G5, G7, G8, G9, G10, G11, G12, G13, G14, G15, G16, G18, H7, H8, H9, H10, H11, H12, H13, H14, H15, H16, J7, J8, J9, J10, J11, J12, J13, J14, J15, J16, K7, K8, K9, K10, K11, K12, K13, K14, K15, K16, L8, L9, L10, L11, L12, L13, L14, L15, M7, M8, M9, M10, M11, M12, M13, M14, M15, M16, N7, N8, N9, N10, N11, N12, N13, N14, N15, N16, P7, P8, P9, P10, P11, P12, P13, P14, P15, P16, R7, R8, R9, R10, R11, R12, R13, R14, R15, R16, T4, T7, T8, T9, T10, T11, T12, T13, T14, T15, T16, T19, W7, W16, AB1, AB22	A1, A30, B2,C3, C28, D8, D23, F7, F9, F11, F12, F19, F20, F22, F24, G6, G25, H4, H27, J6, J25, L6, L11, L12, L13, L14, L15, L16, L17, L18, L19, L20, L25, M6, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, M25, N11, N12, N13, N14, N15, N16, N17, N18, N19, N20, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14,U15, U16, U17, U18, U19, U20, V11, V12, V13, V14, V15, V16, V17, V18, V19, V20, W6, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, W25, Y6, Y11, Y12, Y13, Y14, Y15, Y16, Y17, Y18, Y19, Y20, Y25, AB6, AB25, AC4, AC27, AD6, AD25, AE7, AE9, AE11, AE12, AE19, AE20, AE22, AE24, AG8, AG23, AH3, AH28, AK1, AK30
NC[3]	AA1	A14, A15, A16, A17, B14, B15, B16, B17, C13, C14, C15, C16, C17, C18, D13, D14, D15, D16, D17, D18, E13, E14, E15, E16, E17, E18, F13, F14, F15, F16, F17, F18, AE13, AE14, AE15, AE16, AE17, AE18, AF13, AF14, AF15, AF16, AF17, AF18, AG13, AG14, AG15, AG16, AG17, AG18, AH14, AH15, AH16, AH17, AH18, AJ14, AJ15, AJ16, AJ17, AJ18, AK14, AK15, AK16, AK17

1. All grounds must be electrically connected at the board level.
2. Not all grounds internally connected within the device.
3. NC pins are not to be connected to any active signals, VCC or GND.

ispMACH 5768VG Logic Signal Connections

Bank No.	Signal	256 fpBGA	484 fpBGA
0	0C-30	C8	D11
0	0C-28	B6	B11
0	0C-26	A5	E12
0	0C-24	D8	C11
0	0C-22	E8	F12
0	0C-20	B5	B10
0	GNDIO0	GND	GND
0	0C-18	A4	A10
0	0C-16	D7	D10
0	0C-14/VREF0	E7	A9
0	0C-12	C6	E11
0	0C-10	B4	B9
0	0C-8	A3	F11
0	0C-6	NC	A8
0	0C-4	NC	C10
0	0C-2	NC	A7
0	0C-0	NC	E10
0	0D-30	NC	B8
0	0D-28	NC	C8
0	GNDIO0	GND	GND
0	0D-26	NC	F10
0	0D-24	NC	A6
0	0D-22	NC	F9
0	0D-20	NC	C7
0	0D-18	NC	D9
0	0D-16	NC	B7
0	0D-14	D6	E8
0	0D-12	E6	A5
0	0D-10	A2	F8
0	0D-8	B3	C6
0	0D-6	C4	D8
0	0D-4	D5	A3
0	GNDIO0	GND	GND
0	0D-2	NC	A2
0	0D-0	NC	A4
0	0A-0	NC	F7
0	0A-2	NC	C5
0	0A-4	NC	F6
0	0A-6	NC	B3
0	0A-8	NC	NC
0	0A-10	NC	NC
0	GNDIO0	GND	GND
0	0A-12	NC	NC

Bank No.	Signal	256 fpBGA	484 fpBGA
0	0A-14	NC	NC
0	0A-16	NC	B4
0	0A-18	NC	D5
0	0A-20	NC	B1
0	0A-22	NC	D6
0	0A-24	NC	C4
0	0A-26	NC	E4
0	GNDIO0	GND	GND
0	0A-28	B2	C2
0	0A-30	B1	C1
0	0B-30	C2	D1
0	0B-28	C1	D2
0	0B-26	NC	D3
0	0B-24	NC	E1
0	0B-22	NC	E3
0	0B-20	NC	F4
0	0B-18	NC	F1
0	0B-16	NC	F3
0	0B-14	NC	G6
0	0B-12	NC	G1
0	GNDIO0	GND	GND
0	0B-10	NC	G2
0	0B-8	NC	H1
0	0B-6	NC	G3
0	0B-4	NC	H2
0	0B-2	NC	H5
0	0B-0	NC	H6
0	1A-0	F7	J1
0	1A-2	F6	K1
0	1A-4	E5	H3
0	1A-6	D4	J2
0	1A-8	D3	H4
0	1A-10	D2	K2
0	GNDIO0	GND	GND
0	1A-12	D1	J6
0	1A-14	E4	L1
0	1A-16	NC	K3
0	1A-18	NC	J4
0	1A-20	NC	L2
0	1A-22	NC	M1
0	1A-24	NC	K6
0	1A-26	NC	K4
0	1A-28	NC	L3

ispMACH 5768VG Logic Signal Connections (Continued)

Bank No.	Signal	256 fpBGA	484 fpBGA
1	2C-26	T11	AA11
1	2C-28	T12	V12
1	2C-30	R10	AB11
2	3C-30	P9	W12
2	3C-28	R11	Y11
2	3C-26	T13	Y12
2	3C-24	N9	AB12
2	3C-22	M9	U12
2	3C-20	R12	AA12
2	GNDIO2	GND	GND
2	3C-18	P11	Y13
2	3C-16	N10	AB13
2	3C-14	M10	W13
2	3C-12/VREF2	R13	AA13
2	3C-10	T14	U13
2	3C-8	R14	AB14
2	3C-6	M11	V13
2	3C-4	N11	AA14
2	3C-2	P13	U14
2	3C-0	T15	AB15
2	3D-30	T16	Y15
2	3D-28	N12	AB16
2	GNDIO2	GND	GND
2	3D-26	NC	AA15
2	3D-24	NC	W14
2	3D-22	NC	AB17
2	3D-20	NC	Y16
2	3D-18	NC	AA16
2	3D-16	NC	Y17
2	3D-14	NC	AB18
2	3D-12	NC	V15
2	3D-10	NC	AB19
2	3D-8	NC	W15
2	3D-6	NC	AB20
2	3D-4	NC	AA18
2	GNDIO2	GND	GND
2	3D-2	L10	U15
2	3D-0	L11	W17
2	3A-0	K11	U16
2	3A-2	R15	AA19
2	3A-4	NC	V16
2	3A-6	NC	AB21
2	3A-8	NC	NC

Bank No.	Signal	256 fpBGA	484 fpBGA
2	3A-10	NC	NC
2	GNDIO2	GND	GND
2	3A-12	NC	NC
2	3A-14	NC	NC
2	3A-16	NC	Y18
2	3A-18	P15	W18
2	3A-20	R16	AA20
2	3A-22	P16	W19
2	3A-24	N14	Y19
2	3A-26	N13	V19
2	GNDIO2	GND	GND
2	3A-28	N15	Y21
2	3A-30	N16	W20
2	3B-30	M16	AA22
2	3B-28	M12	W21
2	3B-26	NC	Y22
2	3B-24	NC	V20
2	3B-22	M13	V21
2	3B-20	M15	W22
2	3B-18	L16	V18
2	3B-16	L15	U20
2	3B-14	L13	V22
2	3B-12	L14	U19
2	GNDIO2	GND	GND
2	3B-10	L12	U17
2	3B-8	K13	U22
2	3B-6	K15	T20
2	3B-4	K16	T21
2	3B-2	J16	T17
2	3B-0	K12	R20
3	4B-0	J12	R21
3	4B-2	G16	T22
3	4B-4/PLL_FBK1	G15	P21
3	4B-6/PLL_RST1	H12	N20
3	4B-8	G12	R22
3	4B-10	G13	N21
3	GNDIO3	GND	GND
3	4B-12	F16	M18
3	4B-14	F15	N19
3	4B-16	F13	P22
3	4B-18	F14	M20
3	4B-20	F12	N22
3	4B-22	E16	N17

ispMACH 5768VG Logic Signal Connections (Continued)

Bank No.	Signal	256 fpBGA	484 fpBGA
3	4B-24	G11	M19
3	4B-26	F11	M21
3	4B-28	F10	L19
3	4B-30/CLK_OUT1	B11	L20
3	GNDIO3	GND	GND
3	4A-30	NC	M17
3	4A-28	NC	M22
3	4A-26	NC	K20
3	4A-24	NC	L18
3	4A-22	NC	L21
3	4A-20	NC	K19
3	4A-18	NC	L22
3	4A-16	NC	K17
3	4A-14	E13	K22
3	4A-12	B12	L17
3	GNDIO3	GND	GND
3	4A-10	E15	K21
3	4A-8	D15	K18
3	4A-6	NC	J17
3	4A-4	NC	J19
3	4A-2	D16	J22
3	4A-0	E12	J21
3	5B-0	NC	H19
3	5B-2	NC	H20
3	5B-4	NC	H17
3	5B-6	NC	H18
3	5B-8	NC	H22
3	5B-10	NC	H21
3	GNDIO3	GND	GND
3	5B-12	NC	G20
3	5B-14	NC	G22
3	5B-16	NC	G17
3	5B-18	NC	G21
3	5B-20	NC	F19
3	5B-22	NC	F20
3	5B-24	A16	F22
3	5B-26	B15	E22
3	5B-28	A15	E19
3	5B-30	D13	E20
3	5A-30	B14	D22
3	5A-28	B16	D21
3	GNDIO3	GND	GND
3	5A-26	C16	D20

Bank No.	Signal	256 fpBGA	484 fpBGA
3	5A-24	C15	C22
3	5A-22	D14	C18
3	5A-20	A14	C19
3	5A-18	C13	D17
3	5A-16	B13	C21
3	5A-14	NC	NC
3	5A-12	NC	NC
3	GNDIO3	GND	GND
3	5A-10	NC	NC
3	5A-8	NC	NC
3	5A-6	NC	B22
3	5A-4	NC	D18
3	5A-2	NC	B20
3	5A-0	NC	F17
3	5D-0	NC	B19
3	5D-2	NC	C17
3	GNDIO3	GND	GND
3	5D-4	NC	A21
3	5D-6	NC	D15
3	5D-8	NC	A20
3	5D-10	NC	C16
3	5D-12	NC	A19
3	5D-14	NC	F16
3	5D-16	NC	B16
3	5D-18	NC	D14
3	5D-20	NC	A18
3	5D-22	A13	F15
3	5D-24	A12	A17
3	5D-26	A11	B15
3	GNDIO3	GND	GND
3	5D-28	A10	A16
3	5D-30	C11	F14
3	5C-0	A9	C15
3	5C-2	D12	D13
3	5C-4	D11	E15
3	5C-6	B10	F13
3	5C-8	B9	B14
3	5C-10	E11	E13
3	5C-12/VREF3	A8	A15
3	5C-14	D10	D12
3	5C-16	E10	A14
3	5C-18	A7	B13
3	GNDIO3	GND	GND

ispMACH 5768VG Logic Signal Connections (Continued)

Bank No.	Signal	256 fpBGA	484 fpBGA
3	5C-20	C9	A13
3	5C-22	E9	B12
3	5C-24	D9	C13
3	5C-26	B8	A12
3	5C-28	A6	C12
3	5C-30	B7	A11
—	GCLK0	H4	P6
—	GCLK1	J4	R6
—	GCLK2	H14	P17
—	GCLK3	H13	P19
—	GOE0	J15	R18
—	GOE1	H15	R17
—	RESETB	J14	R19
—	TCK	J3	R3
—	TDI	H3	R2
—	TDO	J2	R4
—	TMS	H2	T1
—	TOE	J13	T18

ispMACH 51024VG Logic Signal Connections (Continued)

Bank No.	Signal	484 fpBGA	676 fpBGA
0	1A-30	K5	M3
0	GNDIO0	GND	GND
0	1B-30/CLK_OUT0	N1	M2
0	1B-28	M2	M1
0	1B-26	P1	N6
0	1B-24	L4	N5
0	1B-22	N2	N4
0	1B-20	M3	N3
0	1B-18	L5	N2
0	1B-16	R1	N1
0	1B-14	P2	P6
0	1B-12	N3	P4
0	GNDIO0	GND	GND
0	1B-10	M6	P3
0	1B-8	M5	P2
0	1B-6/PLL_RST0	M4	P1
0	1B-4/PLL_FBK0	N4	R4
0	1B-2	N6	R3
0	1B-0	N5	R2
1	2B-0	NC	R1
1	2B-2	NC	T1
1	2B-4	NC	T3
1	2B-6	NC	T2
1	2B-8	NC	U1
1	2B-10	NC	U2
1	GNDIO1	GND	GND
1	2B-12	NC	U3
1	2B-14	NC	U4
1	2B-16	NC	V1
1	2B-18	NC	V2
1	2B-20	NC	V3
1	2B-22	NC	V4
1	2B-24	NC	W1
1	2B-26	NC	V6
1	2B-28	NC	W2
1	2B-30	NC	W3
1	GNDIO1	GND	GND
1	2A-30	NC	Y1
1	2A-28	NC	W5
1	2A-26	NC	Y2
1	2A-24	NC	Y3
1	2A-22	NC	AA1
1	2A-20	NC	Y4

Bank No.	Signal	484 fpBGA	676 fpBGA
1	2A-18	NC	AA2
1	2A-16	NC	AA3
1	2A-14	NC	AB1
1	2A-12	NC	AB2
1	GNDIO1	GND	GND
1	2A-10	NC	AA5
1	2A-8	NC	AB3
1	2A-6	NC	AC1
1	2A-4	NC	AB4
1	2A-2	NC	AC2
1	2A-0	NC	AD1
1	3B-0	R5	AC3
1	3B-2	T2	AD2
1	3B-4	T5	AE1
1	3B-6	T3	AD3
1	3B-8	U1	AE2
1	3B-10	U4	AC5
1	GNDIO1	GND	GND
1	3B-12	V1	AF1
1	3B-14	U3	AD4
1	3B-16	V5	AE3
1	3B-18	V2	AC6
1	3B-20	W1	AF2
1	3B-22	V3	AG1
1	3B-24	W2	AF3
1	3B-26	Y1	AG2
1	3B-28	Y2	AH1
1	3B-30	W3	AE5
1	3A-30	AA3	AF4
1	3A-28	W4	AG3
1	GNDIO1	GND	GND
1	3A-26	W5	AE6
1	3A-24	Y4	AH2
1	3A-22	T6	AJ1
1	3A-20	Y5	AG4
1	3A-18	U6	AF6
1	3A-16	AA4	AG5
1	3A-14	NC	AH4
1	3A-12	NC	AJ3
1	GNDIO1	GND	GND
1	3A-10	NC	AK2
1	3A-8	NC	AE8
1	3A-6	W6	AH5

ispMACH 51024VG Logic Signal Connections (Continued)

Bank No.	Signal	484 fpBGA	676 fpBGA
1	3A-4	V4	AJ4
1	3A-2	U7	AK3
1	3A-0	AB2	AK4
1	3D-0	V7	AJ5
1	3D-2	AA5	AH6
1	GNDIO1	GND	GND
1	3D-4	AB3	AF8
1	3D-6	Y6	AG7
1	3D-8	AB4	AK5
1	3D-10	Y7	AJ6
1	3D-12	AB5	AH7
1	3D-14	V8	AK6
1	3D-16	AA7	AJ7
1	3D-18	Y8	AH8
1	3D-20	AB6	AG9
1	3D-22	W8	AK7
1	3D-24	AA8	AF10
1	3D-26	Y10	AJ8
1	GNDIO1	GND	GND
1	3D-28	U8	AH9
1	3D-30	AB7	AK8
1	3C-0	U9	AJ9
1	3C-2	AA9	AH10
1	3C-4	W9	AK9
1	3C-6	AB8	AG11
1	3C-8	U10	AJ10
1	3C-10	AB9	AF12
1	3C-12	V11	AH11
1	3C-14/VREF1	AA10	AK10
1	3C-16	V10	AJ11
1	3C-18	AB10	AK11
1	GNDIO1	GND	GND
1	3C-20	W10	AH12
1	3C-22	W11	AJ12
1	3C-24	U11	AK12
1	3C-26	AA11	AH13
1	3C-28	V12	AJ13
1	3C-30	AB11	AK13
2	4C-30	W12	AK18
2	4C-28	Y11	AK19
2	4C-26	Y12	AJ19
2	4C-24	AB12	AH19
2	4C-22	U12	AK20

Bank No.	Signal	484 fpBGA	676 fpBGA
2	4C-20	AA12	AJ20
2	GNDIO2	GND	GND
2	4C-18	Y13	AK21
2	4C-16	AB13	AH20
2	4C-14	W13	AF19
2	4C-12/VREF2	AA13	AJ21
2	4C-10	U13	AG20
2	4C-8	AB14	AK22
2	4C-6	V13	AH21
2	4C-4	AA14	AJ22
2	4C-2	U14	AK23
2	4C-0	AB15	AH22
2	4D-30	Y15	AJ23
2	4D-28	AB16	AK24
2	GNDIO2	GND	GND
2	4D-26	AA15	AF21
2	4D-24	W14	AG22
2	4D-22	AB17	AH23
2	4D-20	Y16	AJ24
2	4D-18	AA16	AK25
2	4D-16	Y17	AH24
2	4D-14	AB18	AJ25
2	4D-12	V15	AK26
2	4D-10	AB19	AJ26
2	4D-8	W15	AH25
2	4D-6	AB20	AG24
2	4D-4	AA18	AF23
2	GNDIO2	GND	GND
2	4D-2	U15	AK27
2	4D-0	W17	AK28
2	4A-0	U16	AJ27
2	4A-2	AA19	AH26
2	4A-4	V16	AE23
2	4A-6	AB21	AK29
2	4A-8	NC	AJ28
2	4A-10	NC	AH27
2	GNDIO2	GND	GND
2	4A-12	NC	AG26
2	4A-14	NC	AF25
2	4A-16	Y18	AJ29
2	4A-18	W18	AG27
2	4A-20	AA20	AJ30
2	4A-22	W19	AH29

ispMACH 51024VG Logic Signal Connections (Continued)

Bank No.	Signal	484 fpBGA	676 fpBGA
2	4A-24	Y19	AE25
2	4A-26	V19	AG28
2	GNDIO2	GND	GND
2	4A-28	Y21	AF27
2	4A-30	W20	AE26
2	4B-30	AA22	AH30
2	4B-28	W21	AG29
2	4B-26	Y22	AF28
2	4B-24	V20	AG30
2	4B-22	V21	AF29
2	4B-20	W22	AC25
2	4B-18	V18	AE28
2	4B-16	U20	AF30
2	4B-14	V22	AD27
2	4B-12	U19	AE29
2	GNDIO2	GND	GND
2	4B-10	U17	AC26
2	4B-8	U22	AD28
2	4B-6	T20	AE30
2	4B-4	T21	AD29
2	4B-2	T17	AC28
2	4B-0	R20	AD30
2	5A-0	NC	AC29
2	5A-2	NC	AB27
2	5A-4	NC	AC30
2	5A-6	NC	AB28
2	5A-8	NC	AA26
2	5A-10	NC	AB29
2	GNDIO2	GND	GND
2	5A-12	NC	AB30
2	5A-14	NC	AA28
2	5A-16	NC	AA29
2	5A-18	NC	AA30
2	5A-20	NC	Y27
2	5A-22	NC	Y28
2	5A-24	NC	Y29
2	5A-26	NC	W26
2	5A-28	NC	Y30
2	5A-30	NC	W28
2	GNDIO2	GND	GND
2	5B-30	NC	W29
2	5B-28	NC	W30
2	5B-26	NC	V25

Bank No.	Signal	484 fpBGA	676 fpBGA
2	5B-24	NC	V26
2	5B-22	NC	V27
2	5B-20	NC	V28
2	5B-18	NC	V29
2	5B-16	NC	V30
2	5B-14	NC	U25
2	5B-12	NC	U27
2	GNDIO2	GND	GND
2	5B-10	NC	U28
2	5B-8	NC	U29
2	5B-6	NC	U30
2	5B-4	NC	T27
2	5B-2	NC	T28
2	5B-0	NC	T29
3	6B-0	R21	T30
3	6B-2	T22	R29
3	6B4/PLL_FBK1	P21	R27
3	6B6/PLL_RST1	N20	R28
3	6B-8	R22	R30
3	6B-10	N21	P30
3	GNDIO3	GND	GND
3	6B-12	M18	P29
3	6B-14	N19	P28
3	6B-16	P22	P27
3	6B-18	M20	N30
3	6B-20	N22	N29
3	6B-22	N17	N28
3	6B-24	M19	N27
3	6B-26	M21	N25
3	6B-28	L19	M30
3	6B-30/CLK_OUT1	L20	M29
3	GNDIO3	GND	GND
3	6A-30	M17	M28
3	6A-28	M22	L30
3	6A-26	K20	M26
3	6A-24	L18	L29
3	6A-22	L21	L28
3	6A-20	K19	L27
3	6A-18	L22	K30
3	6A-16	K17	K29
3	6A-14	K22	K28
3	6A-12	L17	J30
3	GNDIO3	GND	GND

Signal Configuration

ispMACH 5768VG and 51024VG 484-ball fpBGA

	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O / VREF3	I/O	I/O	I/O	I/O	I/O	I/O/ VREF0	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	**A**
B	I/O	VCC	I/O	I/O	VCCO3	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	VCCO0	I/O	I/O	VCC	I/O	**B**
C	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	**C**
D	I/O	I/O	I/O	GND	I/O	I/O	VCCO3	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO0	I/O	I/O	GND	I/O	I/O	I/O	**D**
E	I/O	VCCO3	I/O	I/O	VCC	VCCO3	GND	I/O	VCCO3	I/O	I/O	I/O	I/O	VCCO0	I/O	GND	VCCO0	VCC	I/O	I/O	VCCO0	I/O	**E**
F	I/O	VCC	I/O	I/O	VCCO3	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO0	I/O	I/O	VCC	I/O	**F**
G	I/O	I/O	I/O	VCCO3	GND	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	GND	VCCO0	I/O	I/O	I/O	**G**
H	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O	I/O	I/O	I/O	**H**
J	I/O	I/O	VCC	I/O	VCCO3	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	VCCO0	I/O	VCC	I/O	I/O	**J**
K	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O	I/O	I/O	I/O	**K**
L	I/O	I/O	I/O/ CLK_OUT1	I/O	I/O	I/O	GNDP1	GND	GND	GND	GND	GND	GND	GND	GND	VCCP0	GNDP0	I/O	I/O	I/O	I/O	I/O	**L**
M	I/O	I/O	I/O	I/O	I/O	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O/ PLL_RST0	I/O	I/O	I/O	**M**
N	I/O	I/O	I/O/ PLL_RST1	I/O	VCCP1	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	I/O/ PLL_FBK0	I/O	I/O	I/O/ CLK_OUT0	**N**
P	I/O	I/O/ PLL_FBK1	VCC	GCLK3	VCCO2	GCLK2	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GCLK0	VCCO1	VCCJ	VCC	I/O	I/O	**P**
R	I/O	I/O	I/O	RESETB	GOE0	GOE1	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GCLK1	I/O	TDO	TCK	TDI	I/O	**R**
T	I/O	I/O	I/O	GND	TOE	I/O	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	I/O	I/O	GND	I/O	I/O	TMS	**T**
U	I/O	VCC	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	VCC	I/O	**U**
V	I/O	I/O	I/O	I/O	I/O	VCCO2	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	VCCO1	I/O	I/O	I/O	I/O	I/O	**V**
W	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	**W**
Y	I/O	I/O	VCCO2	I/O	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O	I/O	VCCO1	I/O	I/O	**Y**
AA	I/O	VCC	I/O	I/O	I/O	VCC	I/O	I/O	I/O	I/O/ VREF2	I/O	I/O	I/O/ VREF1	I/O	I/O	I/O	VCC	I/O	I/O	I/O	VCC	NC[1]	**AA**
AB	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	**AB**
	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	

ispMACH 5768VG and 51024VG 484BGA/51024VG

Bottom View

1. NCs are not to be connected to any active signals, VCC or GND.

Note: Ball A1 indicator dot on top side of package.

Signal Configuration

ispMACH 51024VG 676-ball fpBGA

	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	A
B	I/O	VCC	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	B
C	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O/ VREF0	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	C
D	I/O	I/O	I/O	I/O	I/O	VCC	I/O	GND	I/O	VCC	I/O	VCC	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	VCC	I/O	VCC	I/O	GND	I/O	VCC	I/O	I/O	I/O	I/O	I/O	D
E	I/O	I/O	I/O	I/O	VCCO3	I/O	VCCO3	I/O	VCCO3	I/O	VCCO3	I/O/ VREF3	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	VCCO0	I/O	VCCO0	I/O	VCCO0	I/O	VCCO0	I/O	I/O	I/O	I/O	E
F	I/O	I/O	I/O	VCC	I/O	I/O	GND	I/O	GND	VCCO3	GND	GND	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	GND	GND	VCCO0	GND	I/O	GND	I/O	I/O	VCC	I/O	I/O	I/O	F
G	I/O	I/O	I/O	I/O	VCCO3	GND																			GND	VCCO0	I/O	I/O	I/O	I/O	G
H	I/O	I/O	I/O	GND	I/O	I/O																			I/O	I/O	GND	I/O	I/O	I/O	H
J	I/O	I/O	I/O	I/O	VCCO3	GND																			GND	VCCO0	I/O	I/O	I/O	I/O	J
K	I/O	I/O	I/O	VCC	I/O	VCCO3																			VCCO0	I/O	VCC	I/O	I/O	I/O	K
L	I/O	I/O	I/O	I/O	VCCO3	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	VCCO0	I/O	I/O	I/O	I/O	L
M	I/O	I/O/ CLK_OUT1	I/O	VCC	I/O	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	I/O	VCC	I/O	I/O/ CLK_OUT0	I/O	M
N	I/O	I/O	I/O	I/O	VCCP1	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	I/O	I/O	I/O	I/O	I/O	N
P	I/O	I/O	I/O	I/O	GCLK3	GNDP1					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	VCCP0	I/O	I/O	I/O	I/O/ PLL_RST0	P
R	I/O	I/O	I/O/ PLL_RST1	I/O/ PLL_FBK1	GOE1	GCLK2					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GNDP0	GCLK0	I/O/ PLL_FBK0	I/O	I/O	I/O	R
T	I/O	I/O	I/O	I/O	GOE0	RESETB					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GCLK1	TDI	TMS	I/O	I/O	I/O	T
U	I/O	I/O	I/O	I/O	TOE	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					VCCJ	TCK	I/O	I/O	I/O	I/O	U
V	I/O	I/O	I/O	I/O	I/O	I/O					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					I/O	TDO	I/O	I/O	I/O	I/O	V
W	I/O	I/O	I/O	VCC	I/O	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	I/O	VCC	I/O	I/O	I/O	W
Y	I/O	I/O	I/O	I/O	VCCO2	GND					GND	GND	GND	GND	GND	GND	GND	GND	GND	GND					GND	VCCO1	I/O	I/O	I/O	I/O	Y
AA	I/O	I/O	I/O	VCC	I/O	VCCO2																			VCCO1	I/O	VCC	I/O	I/O	I/O	AA
AB	I/O	I/O	I/O	I/O	VCCO2	GND																			GND	VCCO1	I/O	I/O	I/O	I/O	AB
AC	I/O	I/O	I/O	GND	I/O	I/O																			I/O	I/O	GND	I/O	I/O	I/O	AC
AD	I/O	I/O	I/O	I/O	VCCO2	GND																			GND	VCCO1	I/O	I/O	I/O	I/O	AD
AE	I/O	I/O	I/O	VCC	I/O	I/O	GND	I/O	GND	VCCO2	GND	GND	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	GND	GND	VCCO1	GND	I/O	GND	I/O	I/O	VCC	I/O	I/O	I/O	AE
AF	I/O	I/O	I/O	I/O	VCCO2	I/O	VCCO2	I/O	VCCO2	I/O	VCCO2	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	VCCO1	I/O	VCCO1	I/O	VCCO1	I/O	VCCO1	I/O	I/O	I/O	I/O	AF
AG	I/O	I/O	I/O	I/O	I/O	VCC	I/O	GND	I/O	VCC	I/O	VCC	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	VCC	I/O	VCC	I/O	GND	I/O	VCC	I/O	I/O	I/O	I/O	I/O	AG
AH	I/O	I/O	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	I/O	I/O	AH
AJ	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O/ VREF2	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	VCC	I/O	AJ
AK	GND	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	NC[1]	NC[1]	NC[1]	NC[1]	I/O	I/O	I/O	I/O/ VREF1	I/O	I/O	I/O	I/O	I/O	I/O	I/O	I/O	GND	AK
	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	

ispMACH 51024VG

Bottom View

676BGA/51024VG

1. NCs are not to be connected to any active signals, VCC or GND.

Note: Ball A1 indicator dot on top side of package.

Industrial

Part Number	Package	Pin Count	Macrocells	Tpd	Voltage
LC51024VG-75F484I	fpBGA	484	1024	7.5	3.3
LC51024VG-10F484I	fpBGA	484	1024	10	3.3
LC51024VG-12F484I	fpBGA	484	1024	12	3.3
LC51024VG-75F676I	fpBGA	676	1024	7.5	3.3
LC51024VG-10F676I	fpBGA	676	1024	10	3.3
LC51024VG-12F676I	fpBGA	676	1024	12	3.3
LC5768VG-75F256I	fpBGA	256	768	7.5	3.3
LC5768VG-10F256I	fpBGA	256	768	10	3.3
LC5768VG-12F256I	fpBGA	256	768	12	3.3
LC5768VG-75F484I	fpBGA	484	768	7.5	3.3
LC5768VG-10F484I	fpBGA	484	768	10	3.3
LC5768VG-12F484I	fpBGA	484	768	12	3.3

Note: the ispMACH 5000VG family is dual-marked with both Commercial and Industrial grades. The Commercial speed grade is one speed grade faster (i.e. LC51024VG-75F484C) than the Industrial speed grade (i.e. LC51024VG-10F484I).

For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 5000VG family:

- *ispMACH 5000VG sysIO Design and Usage Guidelines* (TN1000)
- *ispMACH 5000VG Timing Model Design and Usage Guidelines* (TN1001)
- *Power Estimation in ispMACH 5000VG Devices* (TN1002)
- *ispMACH 5000VG PLL Usage Guidelines* (TN1003)